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		record the attached original documents or copy thereof					
1. Name of conve	eying party(ies):	Name and address of receiving party(ies):					
Paul A. Farrar		Name: Micron Technology, Inc.					
Additional name(s party(ies) attache		Internal Address:  Street Address: 8000 S. Federal Way					
3. Nature of Conv	eyance:						
x Assignment	Merger	City: Boise					
Security Agree	ement Change of Name	State: <u>Idaho</u> Zip: <u>83706-9632</u>					
Other		Country:					
Execution Date(s)	): 3/16/00	Additional name(s) & Yes address(es) attached? x No					
4. Application nur	mber(s) or patent number(s):	09/334224					
	is being filed together with a new applicate(s) of the new application is (are):	cation, 3/16/00					
A. Patent Applica		B. Patent No.(s):					
	ress of party to whom correspondence nent should be mailed:	Additional numbers attached? Yes X No  6. Total number of applications and patents involved:					
Name: DICKSTEIN	SHAPIRO MORIN & OSHINSKY LLP	7. Total fee (37 C.F.R 3.41) \$ \$40.00					
Internal Address:	Atty. Dkt.: M4065.0258/P258	x Enclosed					
00000025 041073 Affi	3534224 n: Thomas J. D'Amico	Authorized to be charged to deposit account					
Street Address:	2101 L Street NW	Credit any overpayment or debit any underpayment					
City: Washington	State:         Zip:           DC         20037 - 1526	8. Deposit account number: 4 - 1073					
	DO NOT USE	THIS SPACE					
9. Statement an	d signature.						
To the best of	-	noing information is true and correct and any attached					
Thomas J. D	Amico Sh	March 24, 2000					
Reg. No. 28,3	Signature 371	Date					
Total number	of pages including cover sheet, atta	achments, and document: 3					

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-4/03/2000 TDADE1

71 FC:581

**PATENT REEL: 010649 FRAME: 0069** 

Docket No.: M4065.0258/P258 Micron No.: 99-0861

## ASSIGNMENT AND AGREEMENT

For value received, I, Paul A. Farrar hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD OF FABRICATING A BARRIER LAYER ON TOP SURFACES OF METALS IN DAMASCENE STRUCTURES, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

PATENT REEL: 010649 FRAME: 0070

Docket No.: M4065.0258/P258

Micron No.: 99-0861

	I agr	ee t	hat, when re	queste	d, I s	shall, without	charge to	Mic	cron Te	chnolo	gy,	
Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable												
or	convenient	in	connection	with	said	applications,	patents,	or	other	forms	of	
pro	otection.											

Paul A. Farrar

Date: March 16 2000

United States of America )

State of South Carolina )ss. County of beautort )

**RECORDED: 03/24/2000** 

On this loth day of march, 2000, before me personally came Paul A. Farrar, to me known to be the

individual described in and who executed the foregoing instrument, and acknowledged

execution of the same.

Notary Public

My Commission Expires October 22, 2009

> PATENT REEL: 010649 FRAME: 0071